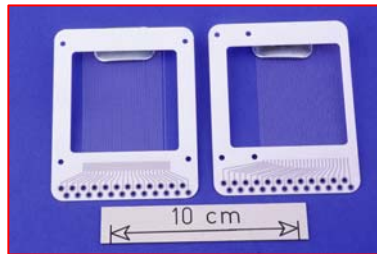


## Transverse Profile Monitoring

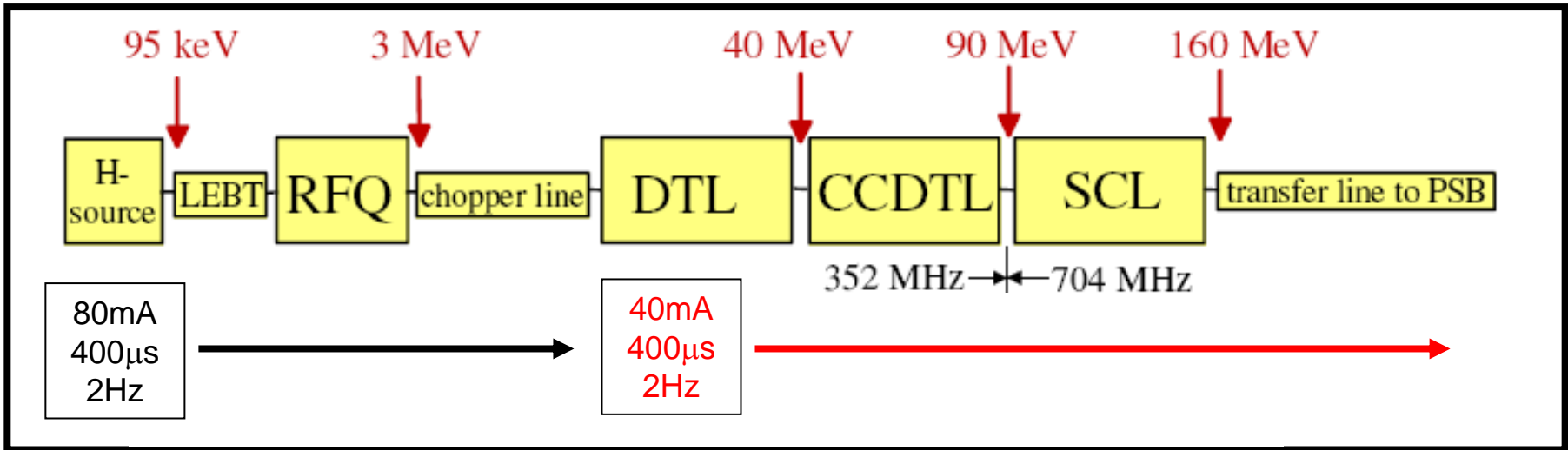


- Requirements
- SEM Grids / Wire Scanners
- Luminescent Screens
- Laser Wire Scanners



Main source of information

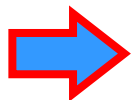
[http://www.sns.gov/diagnostics/diag\\_docs.html](http://www.sns.gov/diagnostics/diag_docs.html)



	LEBT	Chopper line	DTL	CCDTL	SCL	HEBT	Booster Injection	MB
Profile monitor	2	3	1	2	2	6	8	1

SEM Grids in preparation

Recuperate 3 Wire Scanners from LPI

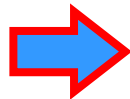


25 Profile monitors

‘SEM Grids’  
‘Wire Scanners’  
‘Screens’  
‘Laser Wire Scanners’

	LEBT	Chopper line	DTL	CCDTL	SCL	HEBT	Booster Injection	MB
Typical RMS Beam size (mm)	<60	<30	<2	<3	<3	<3	<3	<3
<b>Spatial Resolution (mm)</b>	<b>2</b>	<b>0.1</b>	<b>0.5</b>	<b>0.5</b>	<b>0.5</b>	<b>0.5</b>	<b>0.5</b>	<b>0.5</b>
Time Resolution ( $\mu$ s)	20	<i>Tbc</i>	<i>Tbc</i>	<i>Tbc</i>	<i>Tbc</i>	<i>Tbc</i>	<i>Tbc</i>	<i>Tbc</i>
Dynamic Range	<i>Tbd</i>	<i>Tbd</i>	<i>Tbd</i>	<i>Tbd</i>	<i>Tbd</i>	<i>Tbd</i>	<i>Tbd</i>	<i>Tbd</i>
Space constraints	ok	<b>high</b>	<b>high</b>	<b>high</b>	<b>high</b>	<i>Tbd</i>	<i>Tbd</i>	ok

(*Tbd* = To be defined ; *Tbc* : To be confirmed)

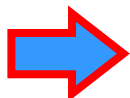
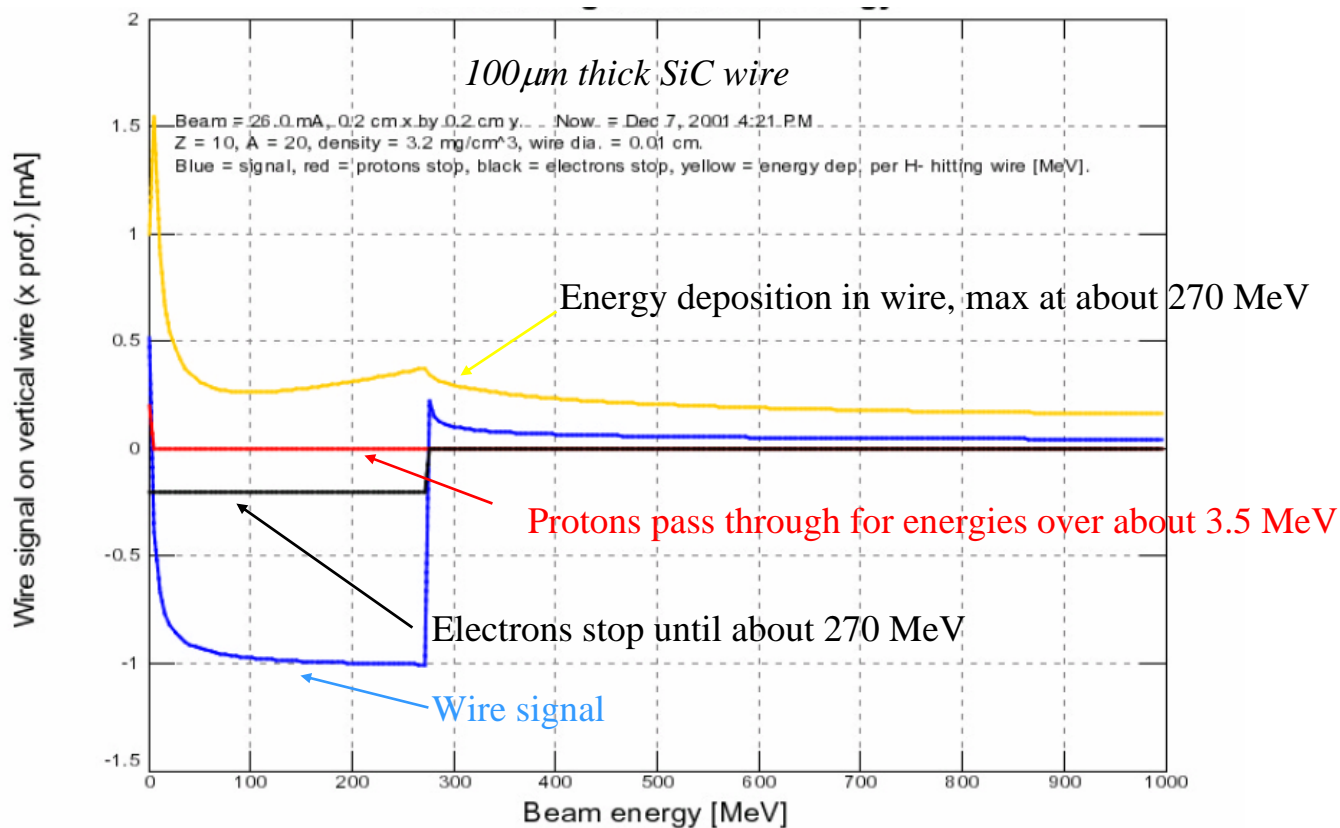


- Spatial and temporal resolution should be easily achievable
- Intense Beam ( $\sim 10^{14}$  particles per pulse)
  - No problem for signal amplitude
  - Beam power and power density are high : Risk of Damage!
- Mechanical design is strongly constraint by space limitation

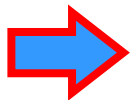
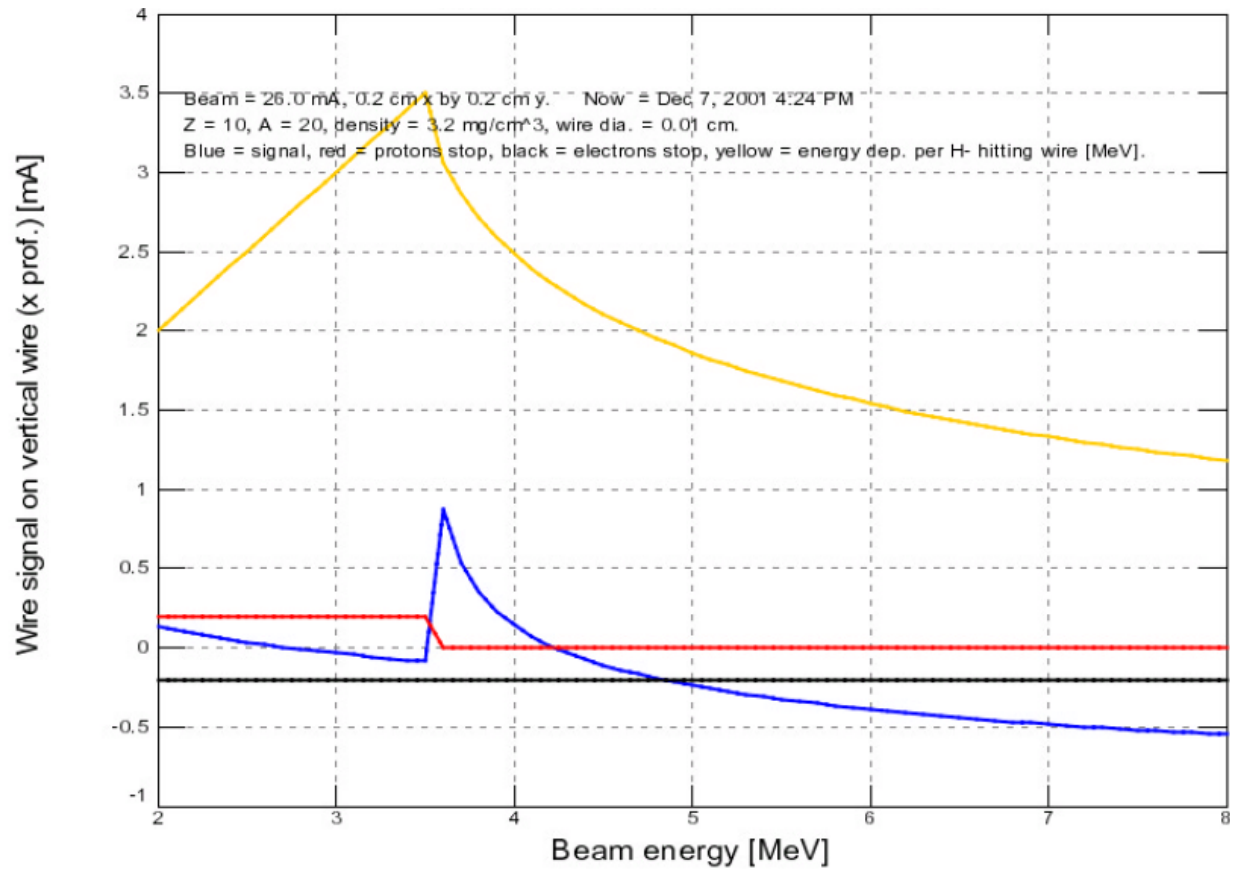
Expected signal



- SEM from H<sup>-</sup>
- Electrons, protons stopping inside the material
- SEM from Electrons and Protons leaving the wire



Depends on wire material and its thickness



Choice of the wire must be done precisely

## Thermal limitations

Cooling from Thermal conduction and black body emission

$$\frac{\Delta T(r, t)}{\Delta t} = \frac{1}{c_p \rho} \left[ \frac{dE}{dx} \rho e^{-\frac{r^2}{2\sigma^2}} N(t) - k \vec{\nabla} \cdot \vec{\nabla} T - \frac{2\varepsilon\sigma_s}{\delta} (T(r, t)^4 - T_0^4) \right]$$

Heating from the beam

### Electron beam characteristics :

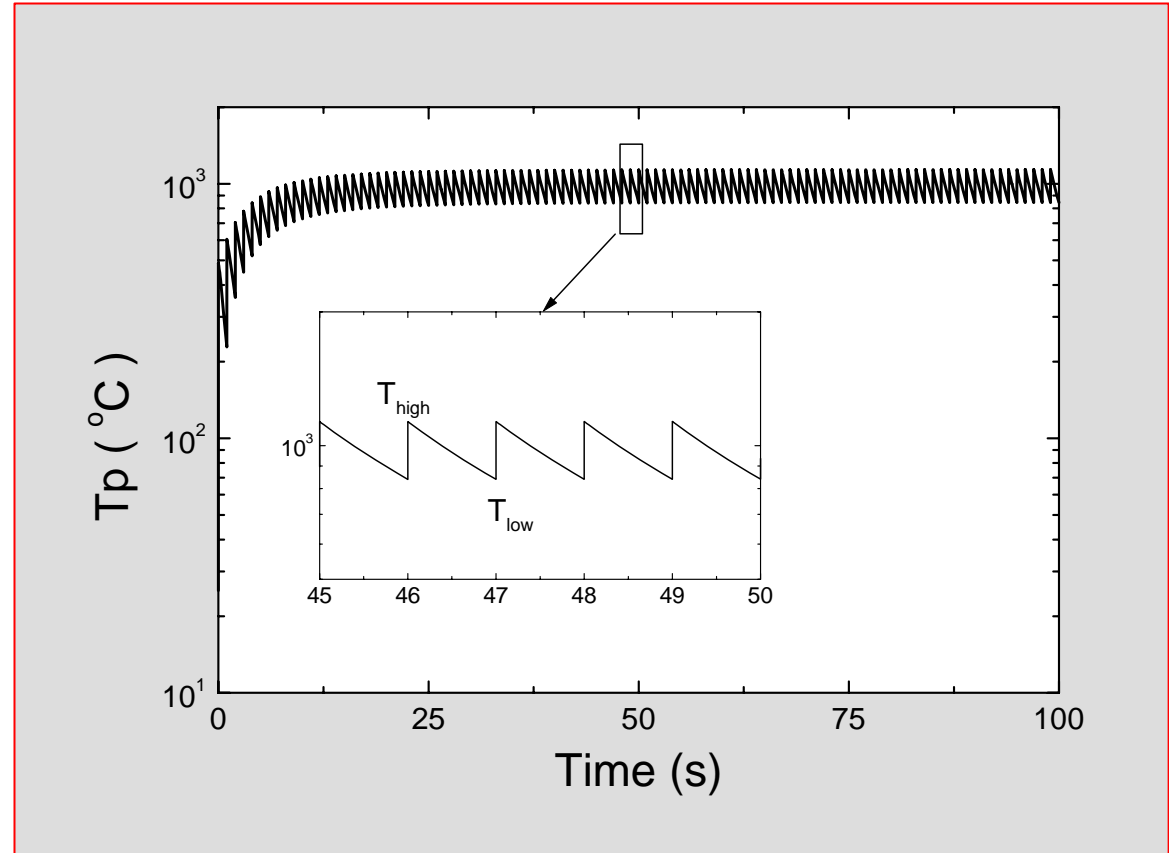
- $\sigma$  : RMS beam size
- Particle Flux :  $N(t)$

*Pulse duration, repetition rate*

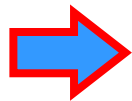
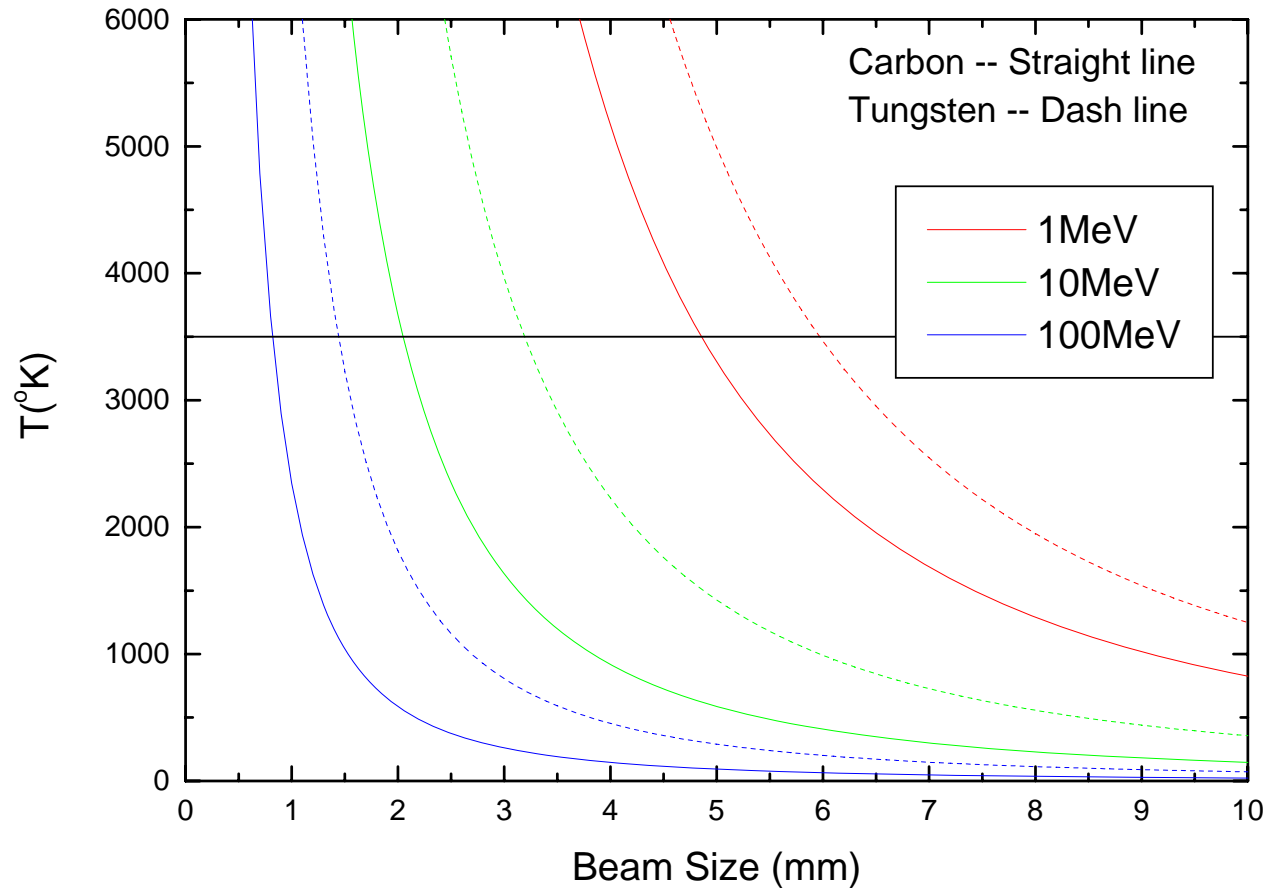
### Target characteristics :

- $\varepsilon$  : Emissivity
- $\delta$  : Thickness
- $c_p$  : Specific heat
- $\rho$  : Density
- $k$  : Thermal conductivity

$\sigma_s$  the Stefan-Boltzmann constant



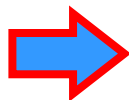
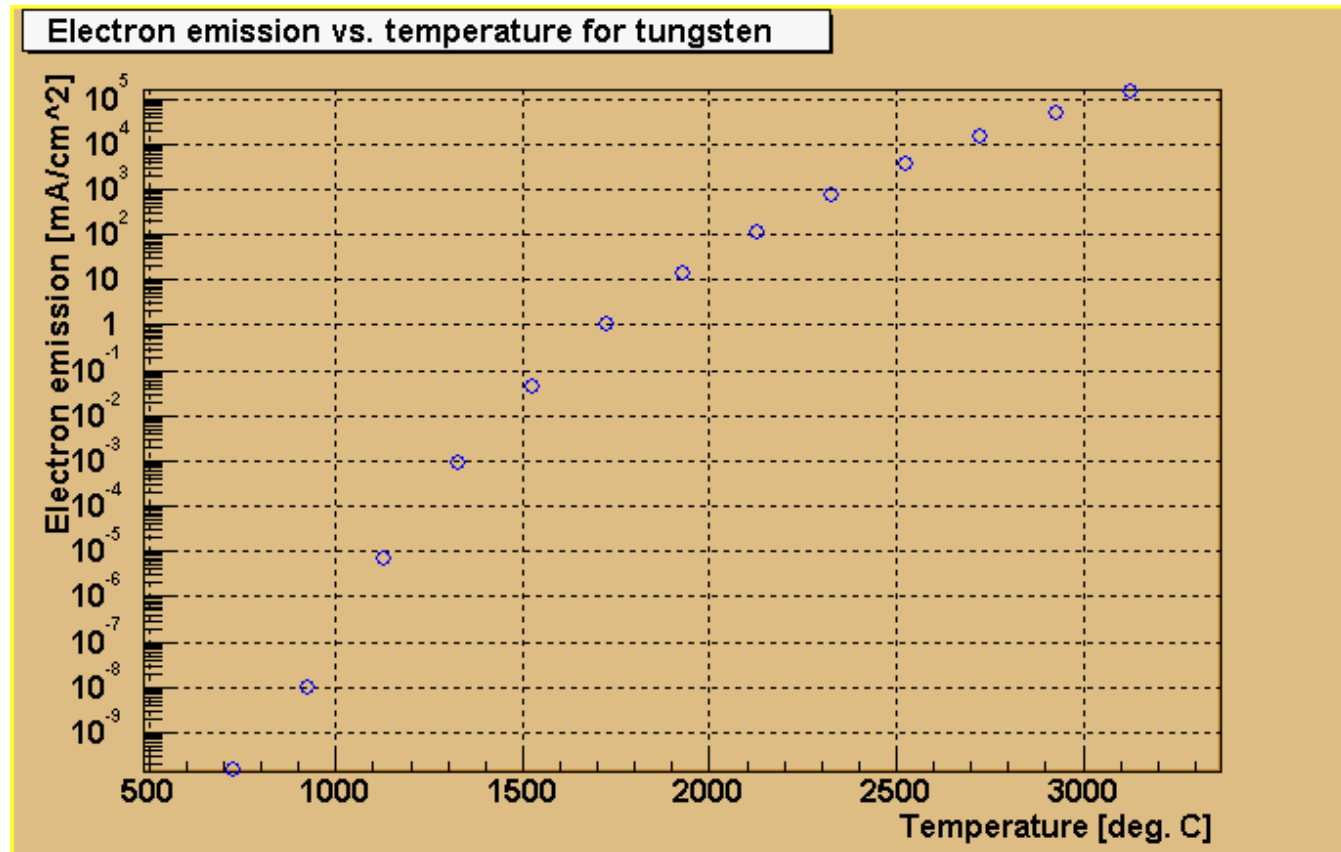
## $\Delta T$ for different materials and different beam energies



There are strong limitations to observe the full beam @low energies

Reduce the pulse length

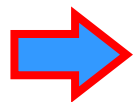
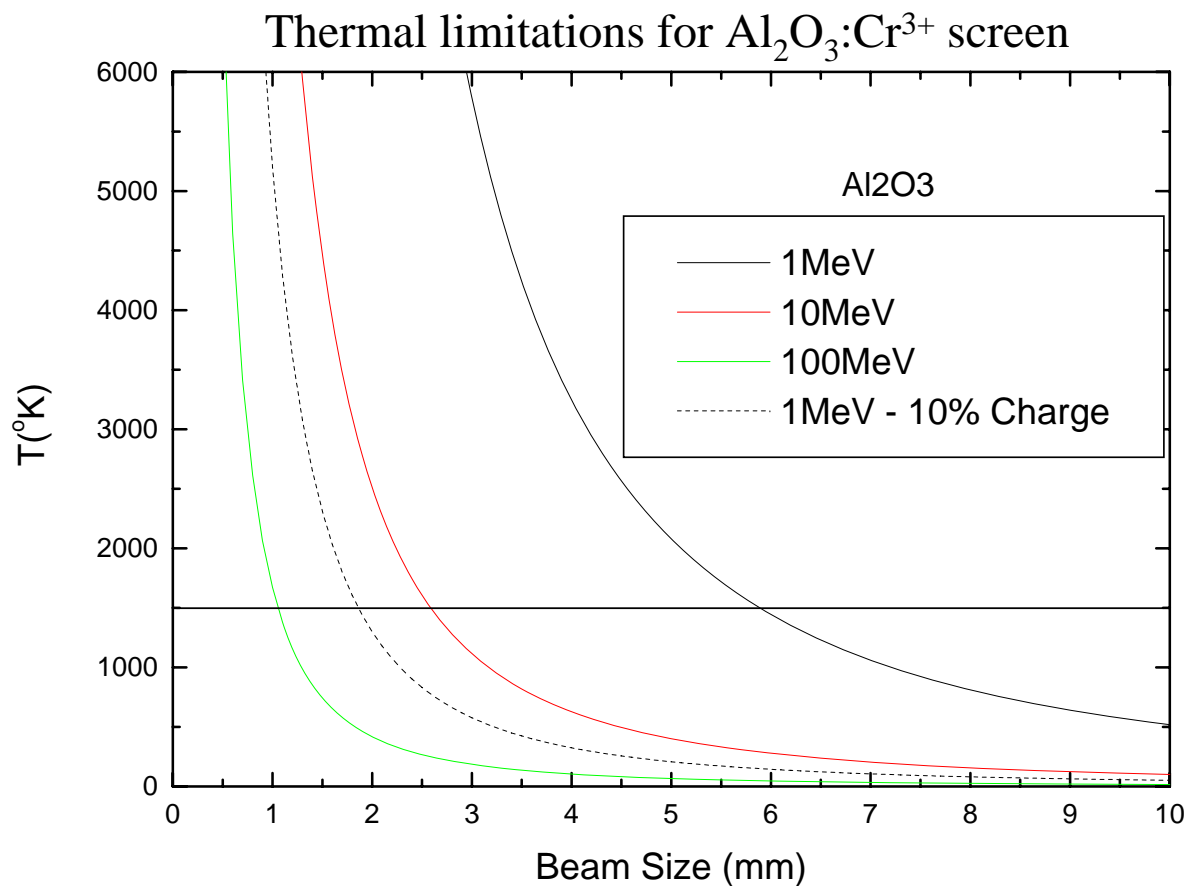
- The peak thermo-ionic current should be at least 100 times lower than the peak secondary electron emission current to avoid substantial contribution to the secondary electron signal.
- Thermo-ionic emission proportional to the wire surface (diameter)



Parameter to be considered in the optimization

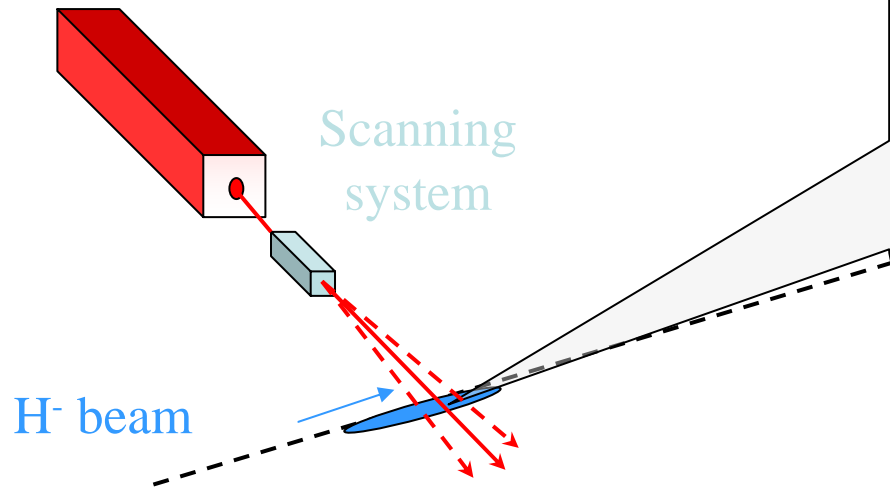


- No limitation from light intensity
- 0.5mm Spatial resolution is easy
- Provide more information than just profiles
- No time resolution with thermal resistant  $\text{Al}_2\text{O}_3$
- Space constraint to be checked
- Thermal limitation

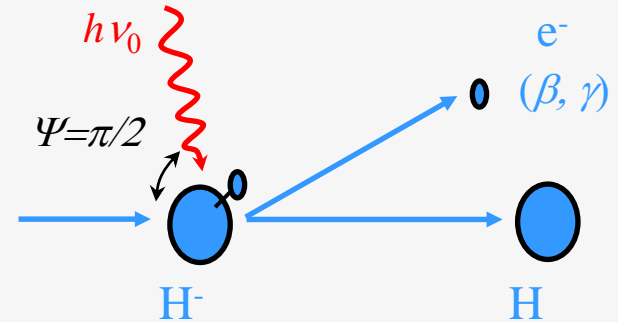


Can be used at higher energies with reduced beam charge

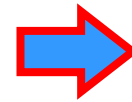
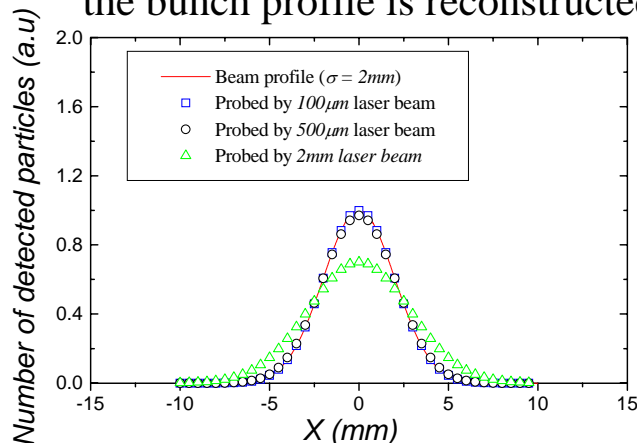
High power laser



## Photo-neutralization



‘By counting the number of the photoneutralization as a function of the laser position the bunch profile is reconstructed ‘

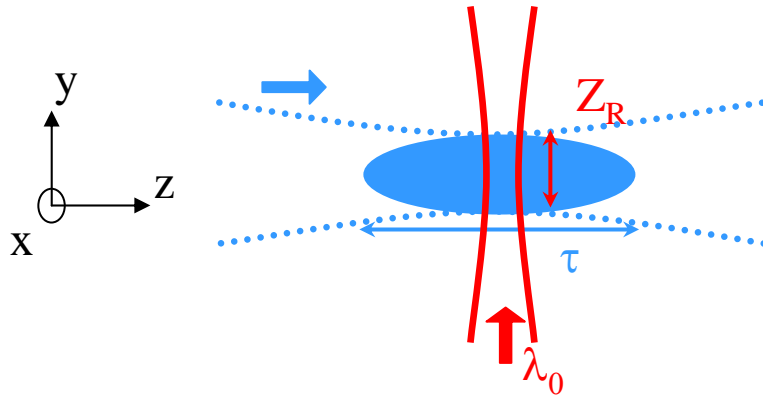


## Based on

- The detection of released electrons using a magnet and a collector
- Measured the decrease of H<sup>-</sup> with a wall current monitor

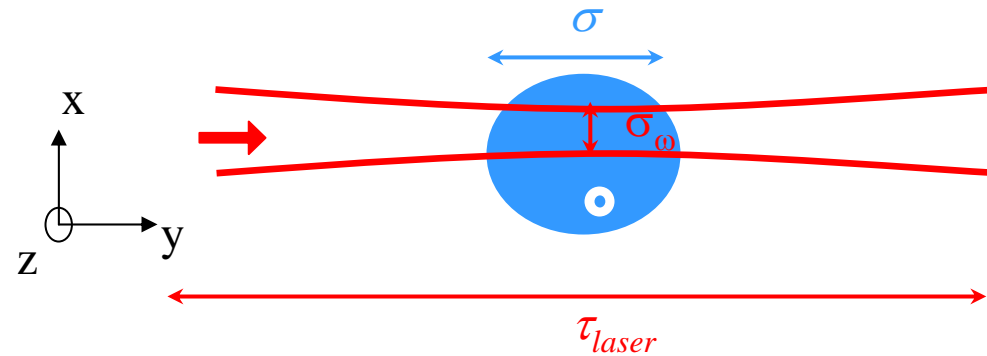
## Laser Beam

- $\lambda_0$  : Laser wavelength
- $\tau_{laser}$  : Laser pulse duration
- $\sigma_\omega$  : RMS spot size
- $Z_R$  : Rayleigh range



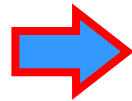
## Particle Beam

- $\tau$  : RMS Bunch length
- $\sigma$  : Transverse RMS beam size



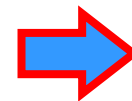
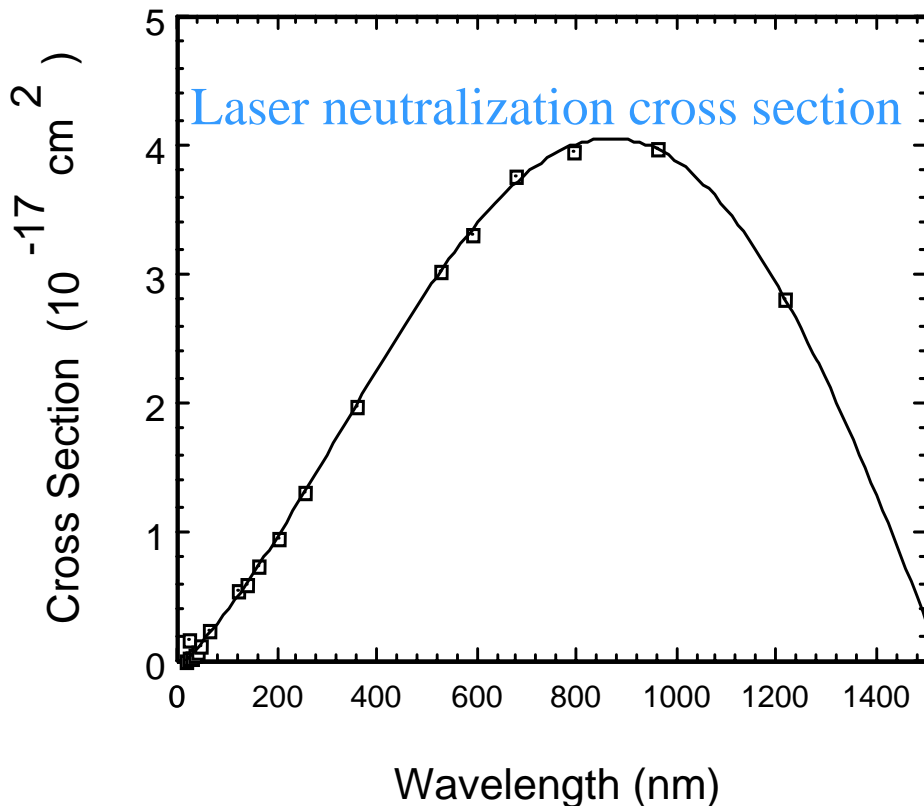
- The number of interactions is given by 
$$N \approx \frac{\sigma \cdot N_p \cdot N_{laser} \cdot \tau_{laser}}{A \cdot \tau}$$

with  $A$  the interaction area,  $N_p$  and  $N_{laser}$  are the number of particles and photons in  $A$



- Efficient for small beam size
- Need high power laser

- First ionization potential for H<sup>-</sup> ions is 0.75eV. Photons with  $\lambda < 1500\text{nm}$  can remove an electron leaving neutral H plus electron
- Photo-neutralization cross section is equal to  $\sigma \sim 4 \cdot 10^{-21} \text{ m}^2$

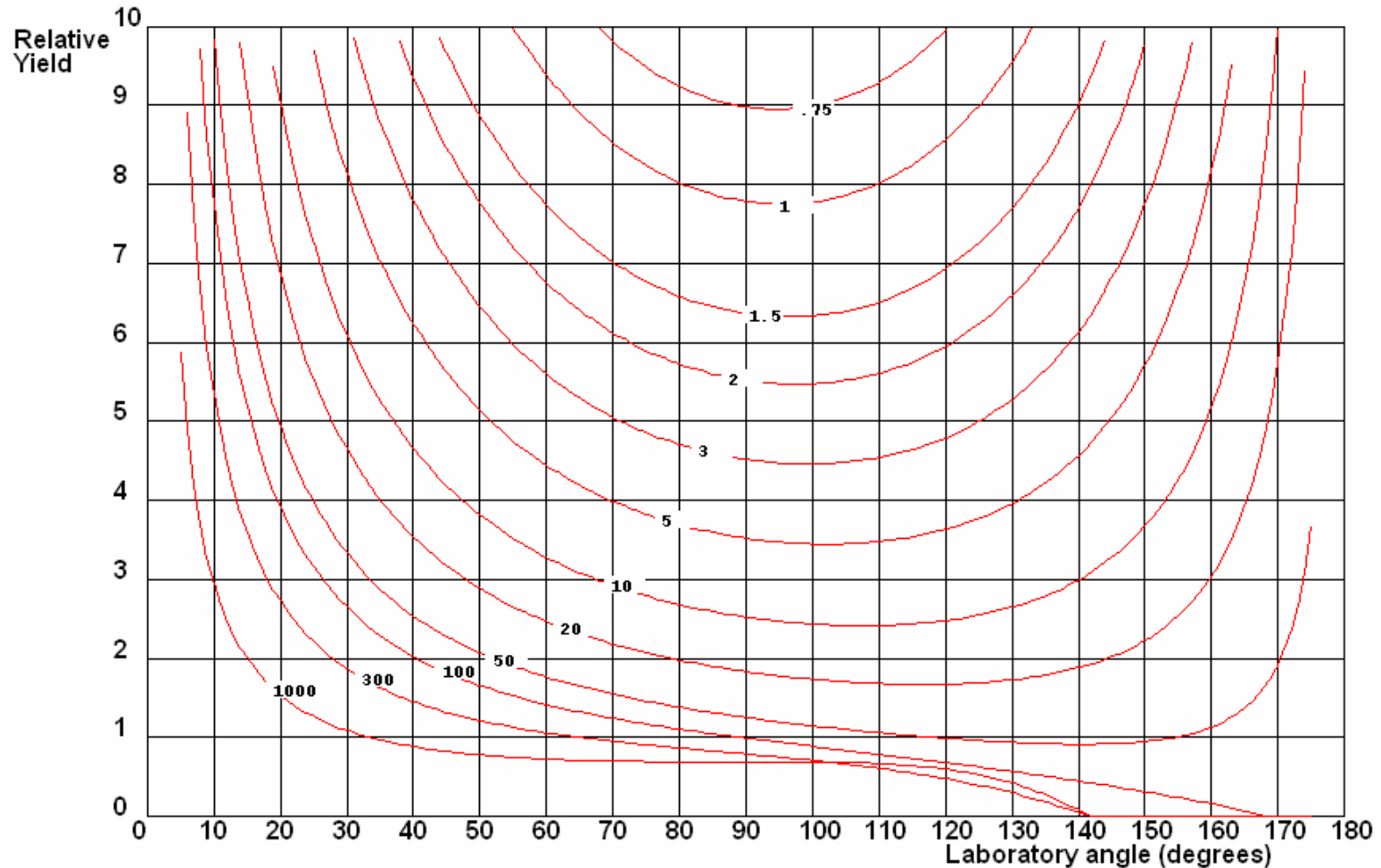


Nd:YAG laser has  $\lambda=1064$  where the cross section is about 90% of the maximum.

*Evolution with  
Beam energy*

$$\lambda \approx \frac{\lambda_0}{\gamma(1 - \beta \cos(\psi))}$$

Relative H- neutralization yield for Nd:YAG laser (1064 nm) vs. lab angle  
for selected beam energies in MeV



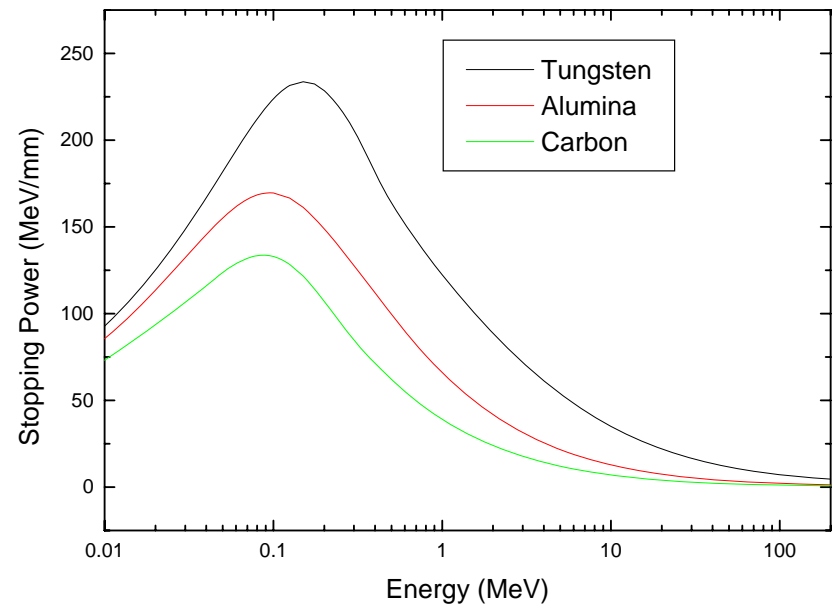
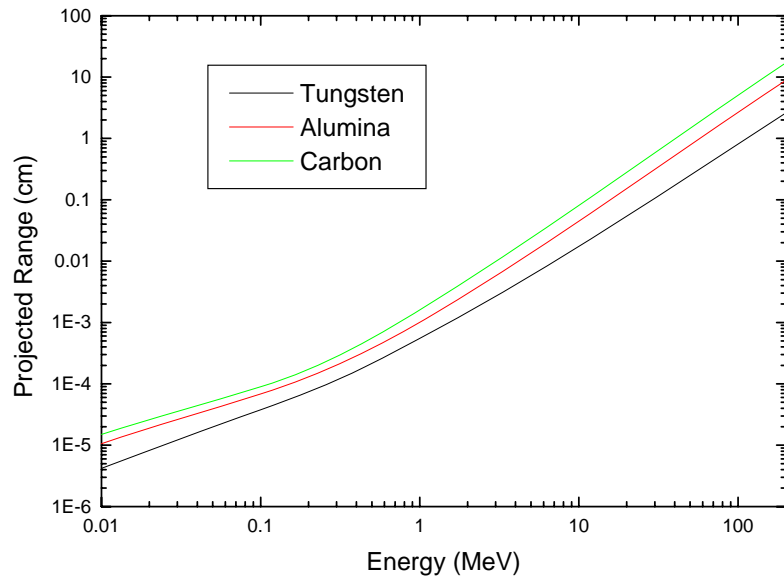
## Laser Wire

- Non perturbative method
- Time resolution possible
- Limited to “small beam size” (~ 2mm) ?
- Limited dynamic range : Possible of background (Stripping from residual gas, Beam losses)
- External magnets are required
- Higher Cost ?

## Conventional Wire

- High risk of damage
- Signal to noise not a problem
- Maintenance requires vacuum access
- Very radiation hard

- Dynamic range and time resolution to be defined for each monitor  
*(design of the electronic)*
  
- Choice of detector is strongly constrained by:
  - Limited space available
  
  - Important thermal limitations for any intercepting devices  
*(SEM/Wire/Screen)*
  
  - Choice of the Wire to be studied
  
- Screens and Laser wire scanner present some advantages and should be investigated

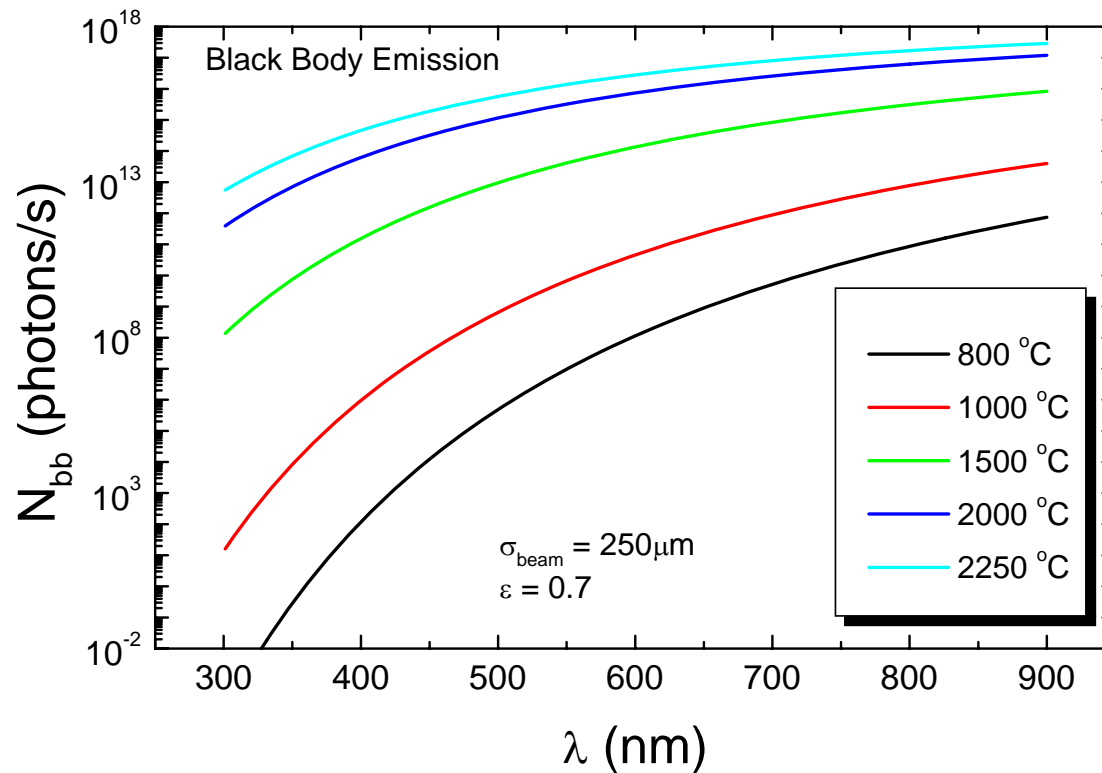




The number of Black body photons emitted per second in the wavelength range  $[\lambda_a, \lambda_b]$  and in  $2\pi$  sr is given by:

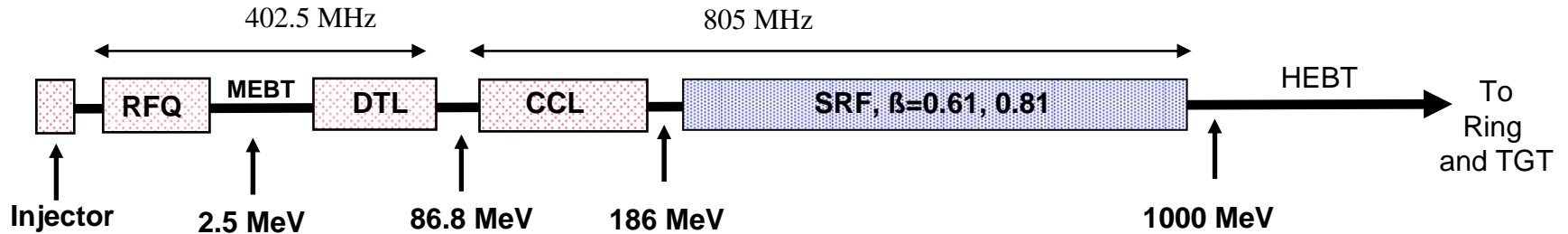
$$N_{BB} = \int_{\lambda_a}^{\lambda_b} \frac{2\pi c}{\lambda^4} \frac{2\pi\sigma^2 \varepsilon}{\frac{hc}{e^{kT\lambda}} - 1} d\lambda$$

k the Boltzmann constant, h the Planck constant, and c the speed of light.





# LANL diagnostics deliverables



### MEBT

**5 WS (elec. only)**  
 6 BPM (elec. only)  
 2 SI&Col (act. only)

### DTL

**5 WS**  
 10 BPM  
 6 CM (p/u only)  
 5 ED/FC

### D-plate (7.5 MeV)

**1 WS**  
 3 BPM  
 1 CM (p/u only)  
 1 ED/FC  
 2 SI&Coll emit  
 1 Phosphor screen  
 1 8 seg. halo scraper  
 1 Beam stop / F-Cup

### CCL

**8 WS**  
 12 BPM  
 2 CM (p/u only)  
 1 ED/FC

### SCL

**32 WS (16 elec.)**  
 32 BPM

### HEBT

**3 WS (dumps)**  
 22 BPM (elec. only)

### RTBT

1 Harp

### Key

WS = wire scanner  
 BPM = beam position monitor  
 SI&Col = slit and collector emittance station  
 CM = current monitor  
 ED/FC = energy degrader & Faraday Cup

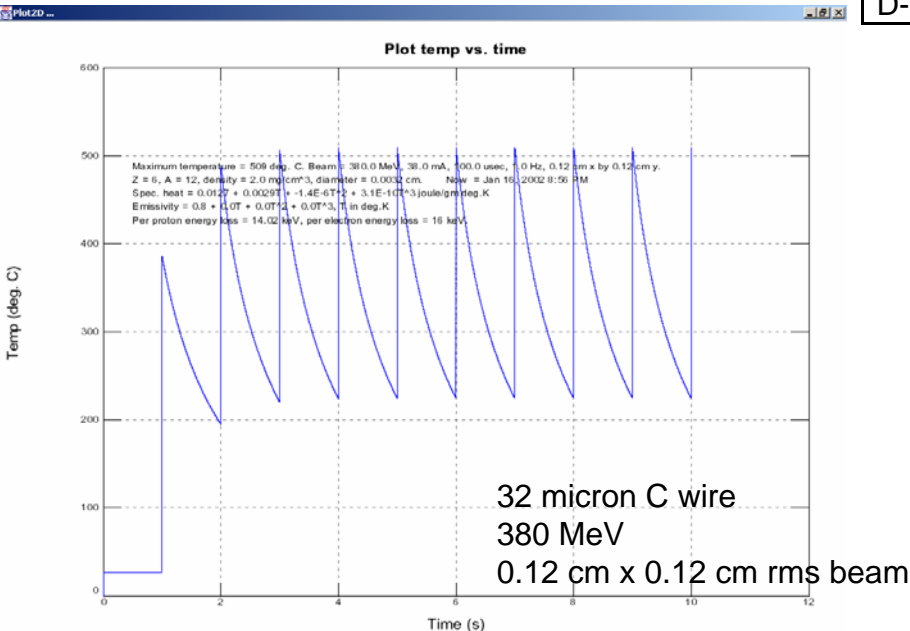
Parameter	x profile	y profile
Wire type	Tungsten	Tungsten
Length of thermal emission	14 cm	6.5 cm
<b>Results – 25 micron dia. tungsten</b>		
Wire area	0.11 cm <sup>2</sup>	0.051 cm <sup>2</sup>
Max allowable thermal emission**	0.0056 mA	0.021 mA
Max allowable thermal emission	0.051 mA/cm <sup>2</sup>	0.41 mA/cm <sup>2</sup>
Max allowable temperature	1500 deg. C	1600 deg. C
<b>Results – 100 micron dia. tungsten</b>		
Wire area	0.44 cm <sup>2</sup>	0.20 cm <sup>2</sup>
Max allowable thermal emission**	0.026 mA	0.098 mA
Max allowable thermal emission	0.059 mA/cm <sup>2</sup>	0.49 mA/cm <sup>2</sup>
Max allowable temperature	1500 deg. C	1600 deg. C

\*\* 1% of peak wire signals in Table 1.

- 32 micron dia. carbon wire.
- Electronics should measure down to 1% of weakest signal from 5 mA avg. beam current, and up to about 200% of strongest signal from 26 mA avg. beam current
- Total current range is 16 nA to 1.8 mA.

Signals at center of beam, 26 mA avg. beam current

Location	Energy (MeV)	rms, min (cm)	signal (uA)	rms, max (cm)	signal (uA)
MEBT	2.5	0.1	-81	0.37	-22
DTL 1	7.5	0.092	-480	0.17	-260
DTL 2	22.9	0.086	-670	0.15	-380
DTL 3	39.8	0.10	-610	0.11	-550
DTL 4	56.5	0.073	-850	0.13	-480
DTL 5	72.5	0.11	-570	0.11	-570
DTL 6	86.8	0.071	-890	0.14	-450
CCL 1	88 - 105*	0.10	-640	0.19	-330
CCL 1	108* - 140	0.11	190	0.19	28
CCL 2	140 - 186	0.12	45	0.22	18
SCL 1	186 - 380	0.16	25	0.22	11
SCL 2	380 - 1000	0.12	21	0.22	8.0
D-plate	7.5	0.09	-495	0.23	-195



\*Transition from neg. to pos. signal at about 107 MeV.

Note: Signal levels are accurate to about a factor of two.



# SNS Wire Temperature



- 32 micron C wire.
- Temperatures at center of beam.
- Max temp is 1225 deg. C.
- Requirements are met for all except MEBT (outside the scope of this review).

Location	Energy (MeV)	x (rms, cm)	y (rms, cm)	Temp (°C)	Temp (°C)
MEBT <sup>0</sup>	2.5	0.1	0.37	1370 <sup>1</sup>	
DTL 1	7.5	0.092	0.17	730 <sup>1</sup>	1180 <sup>2</sup>
DTL 2	22.9	0.086	0.15	530 <sup>1</sup>	950 <sup>2</sup>
DTL 3	39.8	0.10	0.11	530 <sup>1</sup>	940 <sup>2</sup>
DTL 4	56.5	0.073	0.13	580 <sup>1</sup>	1010 <sup>2</sup>
DTL 5	72.5	0.11	0.11	530 <sup>1</sup>	940 <sup>2</sup>
DTL 6	86.8	0.14	0.071	620 <sup>1</sup>	1055 <sup>2</sup>
CCL <sup>3</sup>	88 – 186	0.11	0.11	592 <sup>1</sup>	1019 <sup>2</sup>
SCL <sup>4</sup>	186 – 1000	0.16	0.16	320 <sup>5</sup>	665 <sup>6</sup>
D-plate	7.5	0.23	0.09	620 <sup>1</sup>	1055
D-plate	7.5	0.21	0.21	400 <sup>1</sup>	780 <sup>2</sup>

<sup>0</sup> WS #5

<sup>1</sup> 1 Hz, 50 us, 26 mA beam

<sup>2</sup> 10 Hz,

<sup>3</sup> 106 MeV

<sup>4</sup> 200 MeV

<sup>5</sup> 1 Hz, 100 us, 26 mA

<sup>6</sup> 10 Hz, 100 us, 26 mA

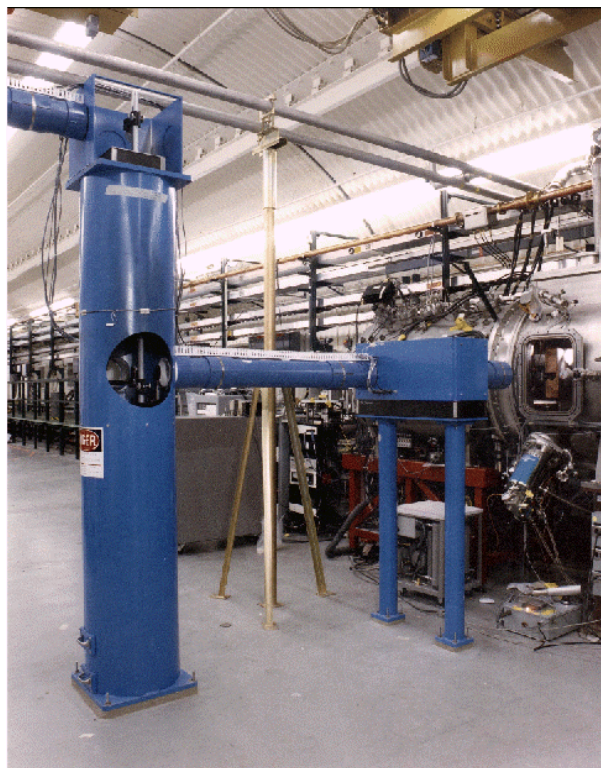
## Single laser station

- 1) More resources available for a higher quality laser
- 2) Requires some sort of distribution system

## One laser per station

- 1) Simple
- 2) Quality of laser severely limited by the budget

**Choice: Single laser**



## Q-switched laser

- 1) Less expensive
- 2) Not necessary to match the phase of the ion pulse train
- 3) Only 1% of the laser energy overlaps with the ion pulses

## Mode-locked laser

- 1) All of the optical energy available for neutralization
- 2) Because less energy per pulse is needed, optical damage is less likely
- 3) Longitudinal profiling also possible
- 4) More expensive
- 5) Pulses must be properly timed

**Choice: Q-switched laser**

## Distribution by fiber

- 1) Optical damage likely, especially with longer, Q-switched pulses.
- 2) Radiation darkening would be a serious problem.
- 3) For mode-locked pulses, additional dispersion compensation would be required

## Distribution by direct beam propagation

- 1) Optical damage less likely
- 2) System should accommodate multiple laser systems
- 3) Active stabilization may be necessary

**Choice: Direct beam propagation**



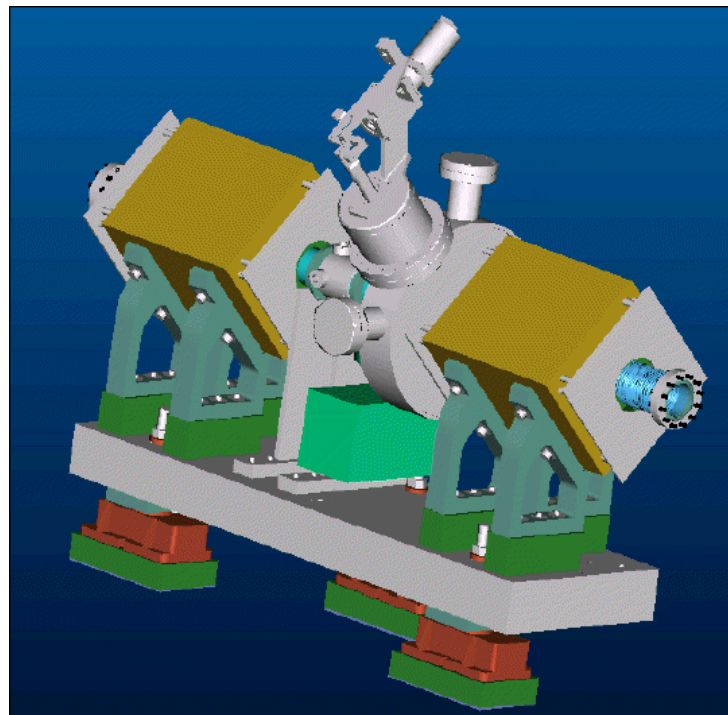
## Beamline optics in vacuum

1) Requires “vacuum-safe” optical stages and mirror mounts

**Choice: Dry purge**

## Beamline optics in dry purge

- 1) Special stages and mounts not required
- 2) Purge should be sufficient to keep optics clean.





- Sources of background are
  - Stripping on residual gas
    - 38mA; 200MeV;  $1e-9$  torr nitrogen; 1ms:  $3.3e6$  electrons/m
      - $10^{-3}$  background in 10cm detector
    - 20mA; 200MeV;  $1e-9$  torr nitrogen; 50us:  $8.7e4$  electrons/m
      - $< 10^{-4}$  background in 10cm detector
  - Beam losses
    - $1W/m \rightarrow Ne = 2e6$  for  $10cm^2$  collector area at 200MeV  
 $Ne = 4e5$  for  $10cm^2$  collector area at 1000MeV
    - Can be major source of background ( $\sim 1e-2$ )
      - Time gating can help
      - Experience from other machines? (PSR, etc.)